Single P-channel MOSFET

ELM14427AA-N

■ General description

ELM14427AA-N uses advanced trench technology to provide excellent Rds(on), low gate charge and low gate resistance. Internal ESD protection is included.

Features

- Vds=-30V
- Id=-12.5A (Vgs=-20V)
- Rds(on) $\leq 12 \text{m} \Omega$ (Vgs=-20V)
- Rds(on) $< 14m \Omega$ (Vgs=-10V)
- ESD Rating: 2000V HBM

■ Maximum absolute ratings

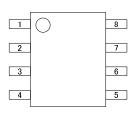
Parameter		Symbol	Limit	Unit	Note
Drain-source voltage		Vds	-30	V	
Gate-source voltage		Vgs	±25	V	
Continuous drain current	Ta=25℃	LJ	-12.5	Δ	1
	Ta=70℃	Id	-10.5	A	
Pulsed drain current		Idm	-60	A	2
Power dissipation	Ta=25℃	D4	3.0	NA.	1
	Ta=70℃	Pd	2.1	W	
Junction and storage temperature range		Tj, Tstg	-55 to 150	$^{\circ}$ C	

■Thermal characteristics

Parameter		Symbol	Тур.	Max.	Unit	Note
Maximum junction-to-ambient	t≤10s	DO:-	28	40	°C/W	1
Maximum junction-to-ambient	Steady-state	Rθja	54	75	°C/W	1
Maximum junction-to-lead	Steady-state	Rθil	21	30	°C/W	3

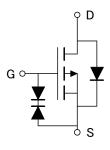
■Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name			
1	SOURCE			
2	SOURCE			
3	SOURCE			
4	GATE			
5	DRAIN			
6	DRAIN			
7	DRAIN			
8	DRAIN			

■ Circuit





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■ Electrical characteristics

Ta=25℃

Parameter	Symbol	Condition		Min.	Тур.	Max.	Unit	
STATIC PARAMETERS								
Drain-source breakdown voltage	BVdss	Id=-250 μA, Vgs=0V		-30			V	
Zero gate voltage drain current	Idss	Vds=-24V				-1	μA	
		$Vg_S=0V$	Tj=55℃			-5	$\mu \Lambda$	
Gate-body leakage current	Igss	Vds=0V, Vgs=±25V				±1	μΑ	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=-250 μ A		-1.7	-2.5	-3.0	V	
On state drain current	Id(on)	Vgs=-10V, Vds=-5V		-60			А	
Static drain-source on-resistance	Rds(on)	Vgs=-20V			9.4	12.0	$_{\mathrm{m}\Omega}$	
		Id=-12.5A	Tj=125℃		12.2	15.0	111 52	
		Vgs=-10V, Id=-10A			11.5	14.0	m Ω	
		Vgs=-4.5V, Id=-5A			32.0		m Ω	
Forward transconductance	Gfs	Vds=-5V, Id=-12.5A			24		S	
Diode forward voltage	Vsd	Is=-1A, Vgs=0V				-1	V	
Max. body-diode continuous current	Is					-4.2	Α	
DYNAMIC PARAMETERS								
Input capacitance	Ciss	Vgs=0V, Vds=-15V, f=1MHz			2330	2900	рF	
Output capacitance	Coss				480		рF	
Reverse transfer capacitance	Crss				320		рF	
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz			6.8	10.0	Ω	
SWITCHING PARAMETERS								
Total gate charge	Qg	Vgs=-10V, Vds=-15V Id=-12.5A			41	52	nC	
Gate-source charge	Qgs				10		nC	
Gate-drain charge	Qgd				12		nC	
Turn-on delay time	td(on)				12.8		ns	
Turn-on rise time	tr	Vgs=-10V, Vds=-	15V		10.3		ns	
Turn-off delay time	td(off)	Rl=1.2 Ω , Rgen=3 Ω			49.5		ns	
Turn-off fall time	tf				29.0		ns	
Body diode reverse recovery time	trr	If=-12.5A, dl/dt=1	00A/μs		28	35	ns	
Body diode reverse recovery charge	Qrr	If=-12.5A, dl/dt=1	$00A/\mu$ s		20		nC	

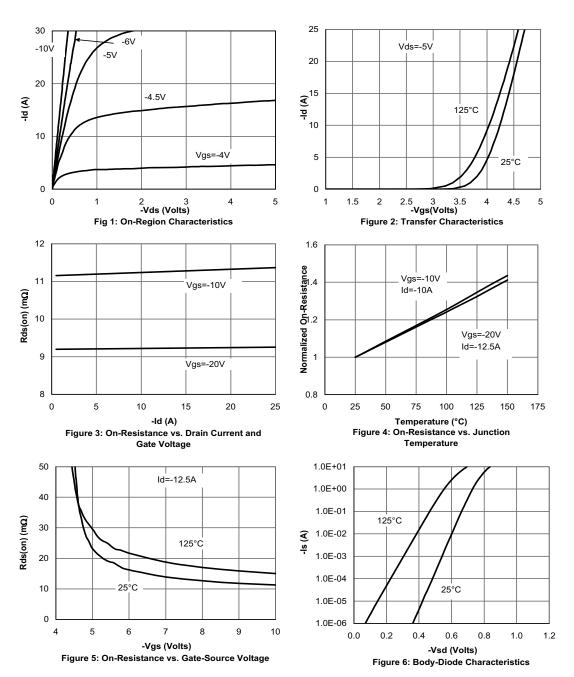
NOTE:

- 1. The value of $R\theta$ ja is measured with the device mounted on 1in^2 FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the $t \leq 10s$ themal resistance rating.
- 2. Repetitive rating, pulse width limited by junction temperature.
- 3. The $R\theta$ is the sum of the thermal impedance from junction to lead $R\theta$ and lead to ambient.
- 4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
- 5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

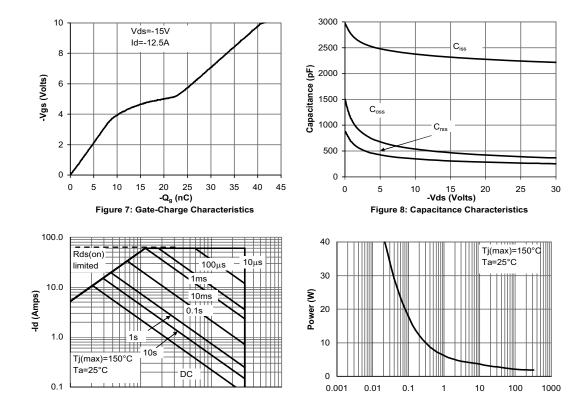


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■Typical electrical and thermal characteristics



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10 D=Ton/T In descending order $T_{j,pk}=T_a+P_{dm}.Z_{\theta ja}.R_{\theta ja}$ D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulse Z_{ðja} Normalized Transient R_{0ja}=40°C/W Thermal Resistance Pd Ton Single Pulse 0.01

100

Pulse Width (s)

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

10

100

1000

10

-Vds (Volts)
Figure 9: Maximum Forward Biased Safe

Operating Area (Note E)

0.1

0.00001

0.0001

0.001

0.01

0.1 Pulse Width (s) Figure 11: Normalized Maximum Transient Thermal Impedance



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